Low Distortion Internally Matched Power GaAs FETs (C-Band)

Features

- Low intermodulation distortion
 - $IM_3 = -45 \text{ dBc}$ at Po = 28 dBm,
 - Single carrier level
- High power
 - P_{1dB} = 39 dBm at 3.7 GHz to 4.2 GHz
- High gain
 - $G_{1dB} = 9.5 dB$ at 3.7 GHz to 4.2 GHz
- Broad band internally matched
- Hermetically sealed package

RF Performance Specifications (Ta = 25° C)

| Characteristics | Symbol | Condition | Unit | Min. | Тур. | Max |
|--|------------------|-----------------------------|------|------|------|------|
| Output Power at 1dB Compression Point | P _{1dB} | | dBm | 38.0 | 39.0 | _ |
| Power Gain at 1dB Compression Point | G _{1dB} | V _{DS} = 10V | dB | 8.5 | 9.5 | _ |
| Drain Current | I _{DS1} | f = 3.7 ~ 4.2 GHz | Α | _ | 2.2 | 2.8 |
| Gain Flatness | ΔG | | dB | _ | _ | ±0.6 |
| Power Added Efficiency | η _{add} | | % | _ | 32 | _ |
| 3rd Order Intermodulation Distortion | IM ₃ | Note 1 | dBc | -42 | -45 | _ |
| Drain Current | I _{DS2} | Note i | Α | _ | 2.2 | 2.8 |
| Channel-Temperature Rise | ΔT_{ch} | $V_{DS}xI_{DS}xR_{th}(c-c)$ | °C | _ | _ | 80 |

Electrical Characteristics (Ta = 25° C)

| Characteristic | Symbol | Condition | Unit | Min. | Тур. | Max |
|-------------------------------|-----------------------|--|------|------|------|------|
| Trans-conductance | gm | $V_{DS} = 3V$ $I_{DS} = 3.0A$ | mS | _ | 1800 | _ |
| Pinch-off Voltage | V _{GSoff} | $V_{DS} = 3V$ $I_{DS} = 40 \text{mA}$ | V | -2 | -3.5 | -5.0 |
| Saturated Drain Current | I _{DSS} | $V_{DS} = 3V$ $V_{GS} = 0V$ | А | _ | 5.8 | 7.5 |
| Gate-Source Breakdown Voltage | V _{GSO} | I _{GS} = -120μA | V | -5 | - | _ |
| Thermal Resistance | R _{th (c-c)} | Channel to case | °C/W | _ | 2.3 | 3.5 |

Note 1: 2 tone Test Pout = 28dBm Single Carrier Level.

The information contained here is subject to change without notice.

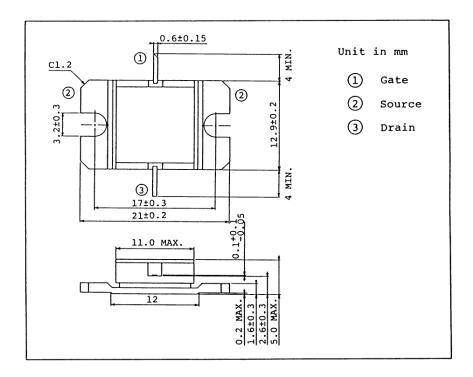
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Absolute Maximum Ratings (Ta = 25° C)

| Characteristic | Symbol | Unit | Rating |
|---|------------------|------|---------|
| Drain-Source Voltage | V _{DS} | V | 15 |
| Gate-Source Voltage | V _{GS} | V | -5 |
| Drain Current | I _{DS} | А | 8 |
| Total Power Dissipation (T _c = 25°C) | P _T | W | 37.5 |
| Channel Temperature | T _{ch} | °C | 175 |
| Storage Temperature | T _{stg} | °C | -65~175 |

Package Outline (2-11D1B)



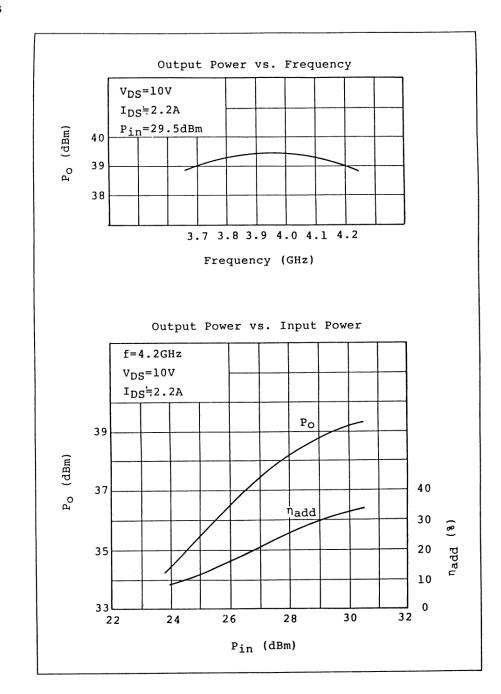
Handling Precautions for Packaged Type

Soldering iron should be grounded and the operating time should not exceed 10 seconds at 260°C.

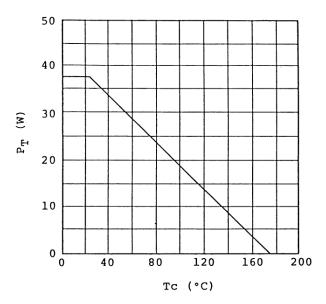
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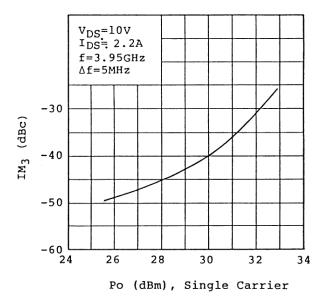
RF Performances



Power Dissipation vs. Case Temperature



IM₃ vs. Output Power Characteristics



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TIM3742-8L S-Parameters (MAGN. and ANGLES)

 $V_{DS}=10V$, $I_{DS}=2.0A$

